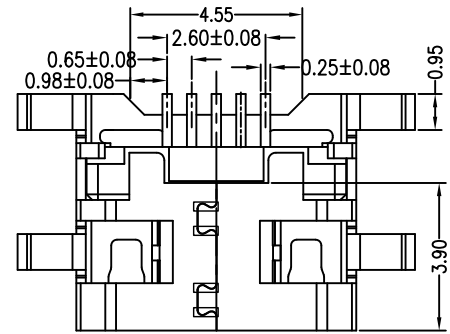
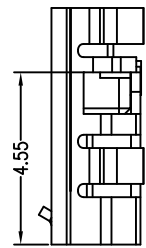
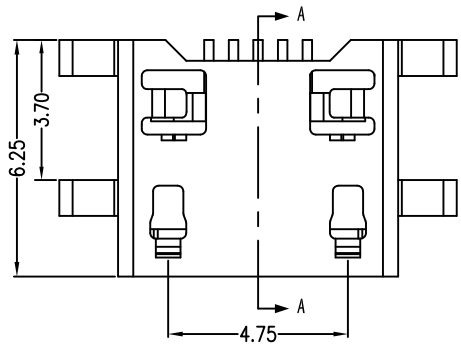
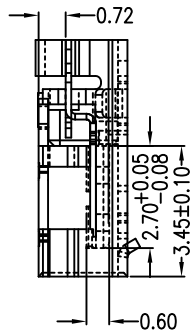
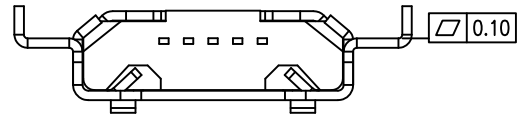
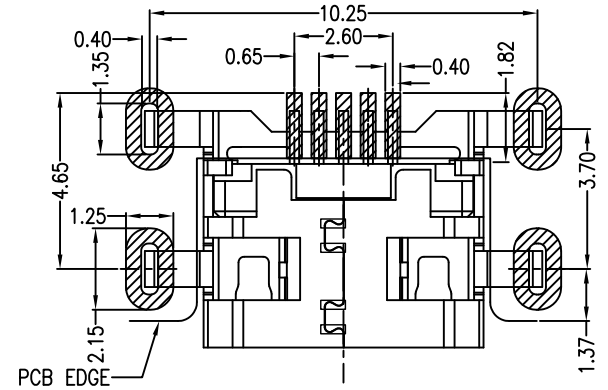
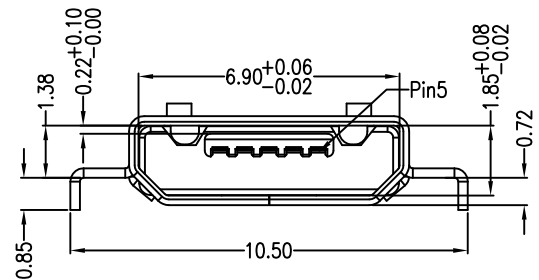


MAPX	MODIFICATION	DATE
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SEC A-A



RECOMMENDED PCB LAYOUT
PCB图仅供参考

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper or sus304,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

产品图 PRODUCT CHART DWG				 Easychips Precision Technology (Zhejiang) Co., Ltd.			
公差一览表				单位	MM	制图	制图料号
TOLERANCE UNLESS OTHERWISE				UNITS		DRAWING	PRODUCT PART NO
X.	±0.35	X.	±5.°	比例	1:1	审核	产品名称
.X	±0.30	.X	±2.°	SCALE		CHKD	无接地LCP黑胶
.XX	±0.20	.XX	±1.°	日期	2016-09-09	核准	角法
.XXX	±0.10	.XXX	±0.5°	DATE		APPD	版本
							VER
							AD

B920-ECF62A2021S10101
MICRO 5S 沉板式0.7四脚插板无边
无接地LCP黑胶
版本 AD